Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from,Europe,America and south Asia,supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of “Quality Parts,Customers Priority,Honest Operation,and Considerate Service”,our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!

Contact us

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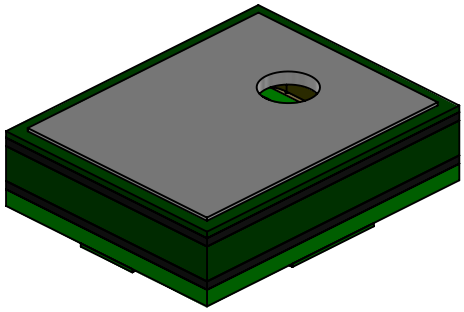
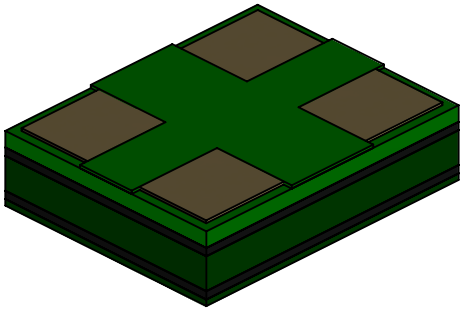
Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China

SPM0404HD5-PB

"Mini" SiSonic™ Microphone Specification - *Halogen Free*





Knowles Acoustics
1151 Maplewood Drive
Itasca, IL 60143

1. DESCRIPTION AND APPLICATION

1.1 DESCRIPTION: "Mini" Surface Mount Silicon Microphone

1.2 APPLICATION: Hand held telecomunication devices.

2. PART MARKING

Identification Number Convention

S	1	2	3
4	5	6	7

S: Manufacturing Location
"S" - Knowles Electronics Suzhou
Suzhou, China

"No Alpha Character" - Knowles Electronics
Itasca, IL USA

"E" - Engineering Samples

Digits 1-7: Job Identification Number

3. TEMPERATURE RANGE

3.1 Operating Temperature Range: -40˚C to +100˚C

3.2 Storage Temperature Range: -40˚C to +100˚C

4. ABSOLUTE MAXIMUM RATINGS

Parameter	Absolute Maximum Rating	Unit
Supply Voltage, V_{DD} to Ground	-0.5, +5.0	V
OUT to Ground	-0.3, V_{DD}+0.3	V
Input Current to Any Pin	±5	mA

Stresses at these Absolute Maximum Ratings may cause permanent damage to the device. These are stress ratings only. The device may not function when operated at these or any other conditions beyond those indicated under “Acoustic & Electrical Specifications”. Exposure beyond those indicated under “Acoustic & Electrical Specifications” for extended periods may affect device reliability.

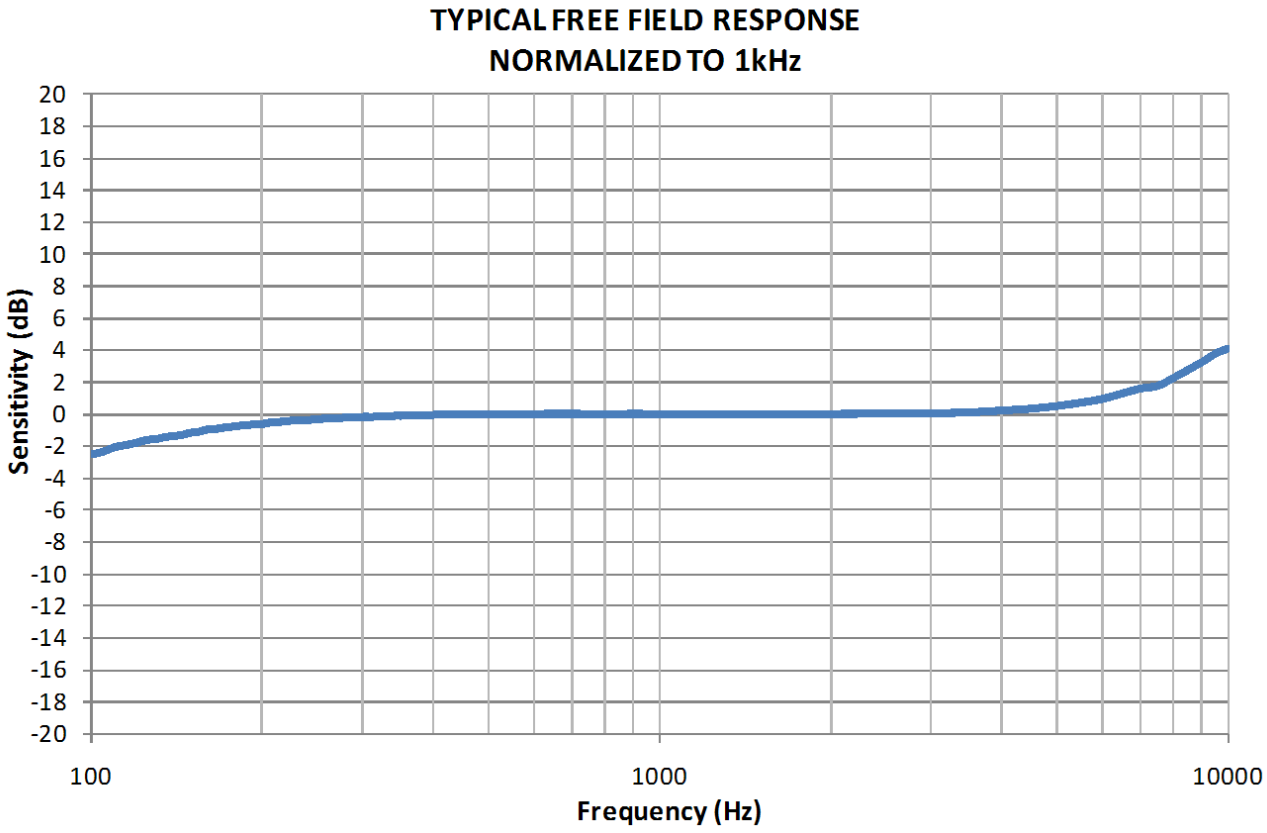
5. ACOUSTIC & ELECTRICAL SPECIFICATIONS

TEST CONDITIONS: 23 ±2°C, 60-70% R.H., $V_{DD}(min) \le V_{DD} \le V_{DD}(max)$, no load, unless otherwise specified

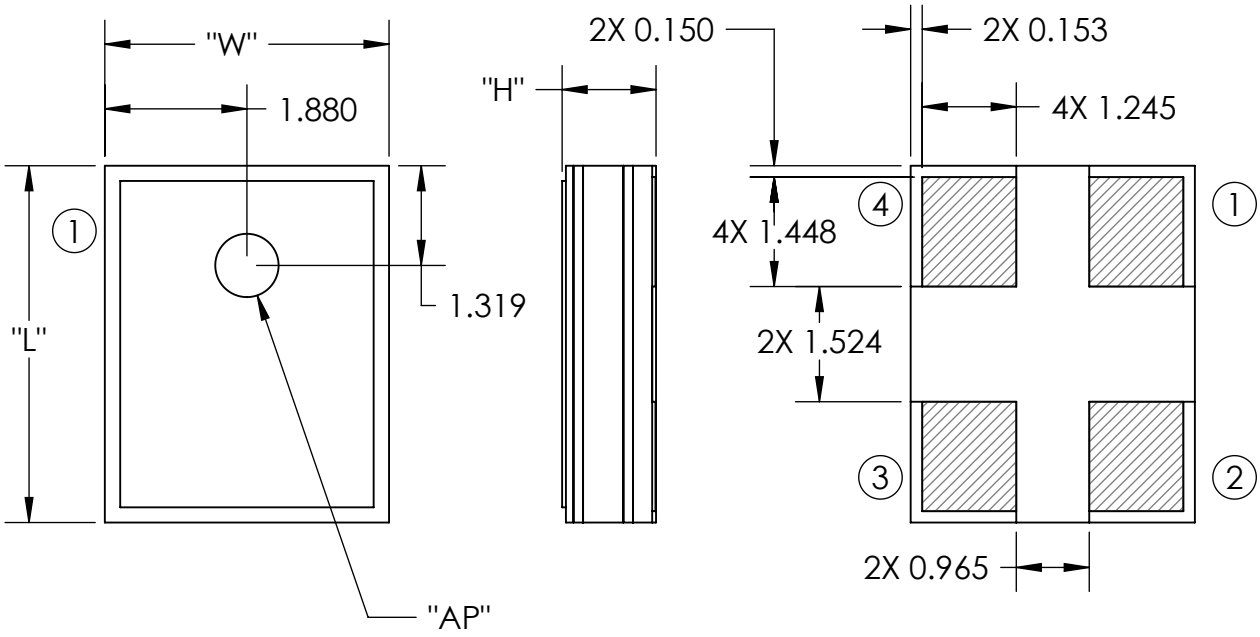
Parameter	Symbol	Condition	Limits			Unit
			Min.	Nom.	Max.	
Supply Voltage[1]	V_{DD}		1.5	---	3.6	V
Current Consumption[1]	I_{DD}		---	---	250	µA
Directivity			Omni-directional			
Sensitivity[1]	S	94 dB SPL @ 1kHz	-45	-42	-39	dBV/Pa
Signal to Noise Ratio	SNR	94 dB SPL @ 1kHz, A-weighted	---	59	---	dB(A)
Output Impedance	Z_{OUT}	@ 1kHz	---	---	100	Ω
Total Harmonic Distortion + Noise	THD+N	100 dB SPL @ 1kHz	---	---	1	%
		115 dB SPL @ 1kHz	---	---	10	%
Polarity		Increasing sound pressure	Decreasing output voltage			

[1] 100% tested

6. FREQUENCY RESPONSE CURVE



7. MECHANICAL SPECIFICATIONS



ITEM	DIMENSION	TOLERANCE	UNITS
LENGTH (L)	4.720	±0.100	mm
WIDTH (W)	3.760	±0.100	mm
HEIGHT (H)	1.250	±0.100	mm
ACOUSTIC PORT (AP)	Ø0.838	±0.100	mm

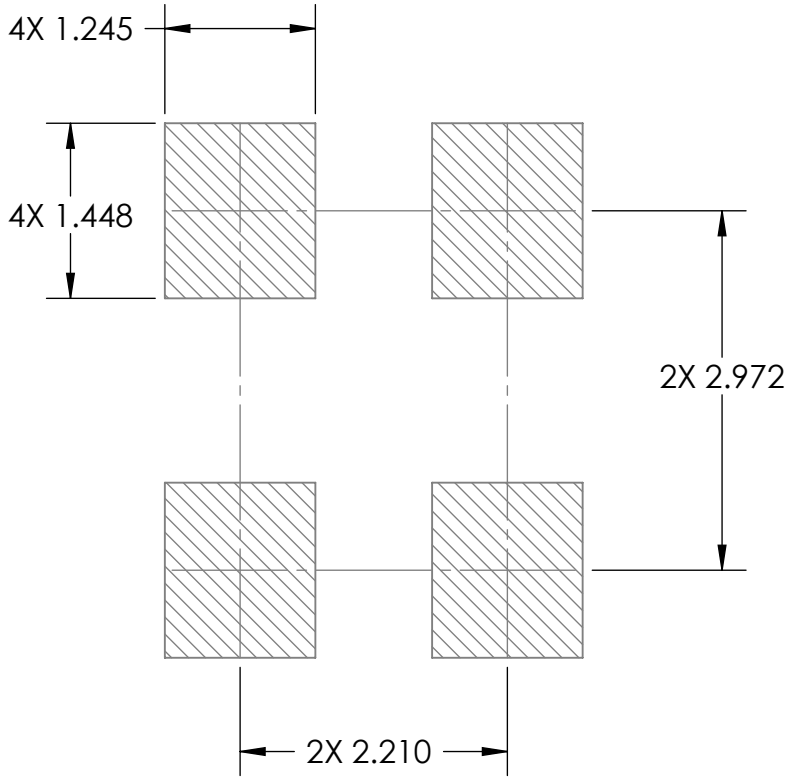
PIN OUTPUT	
PIN #	FUNCTION
1	OUTPUT
2	GROUND
3	GROUND
4	POWER (V_{DD})

Note:

Dimensions are in milimeters unless otherwise specified.

Tolerance ±0.15mm unless otherwise specified.

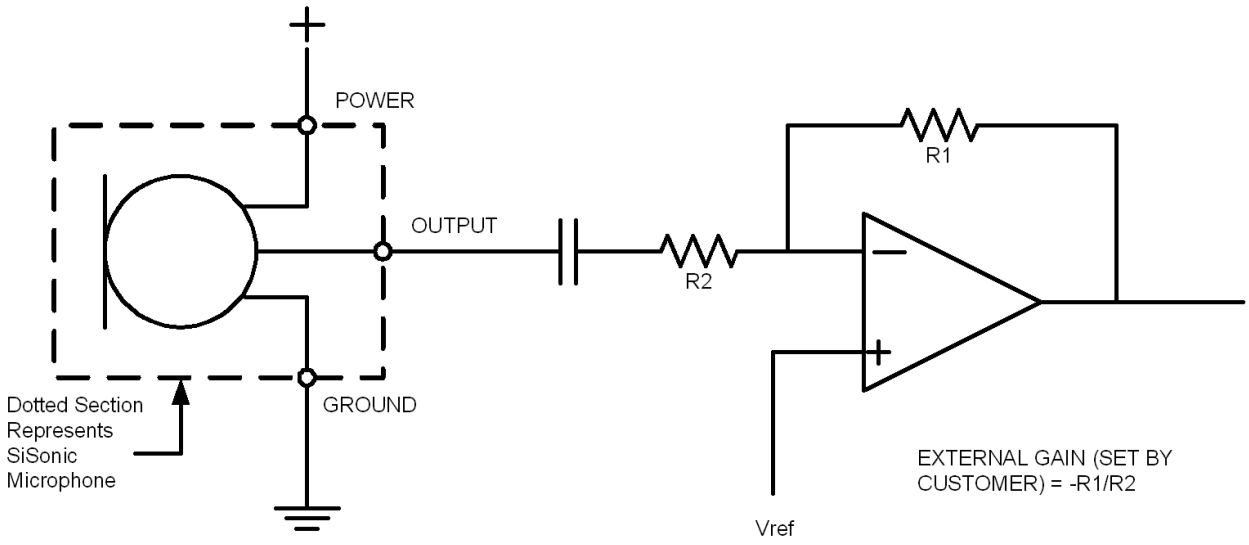
8. RECOMMENDED CUSTOMER LAND PATTERN



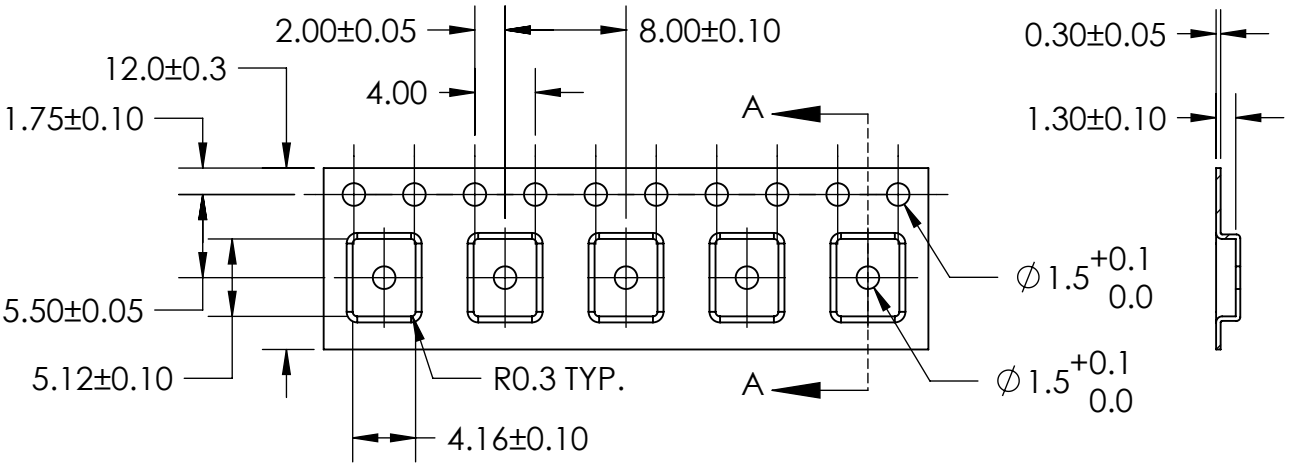
9. RECOMMENDED SOLDER STENCIL PATTERN

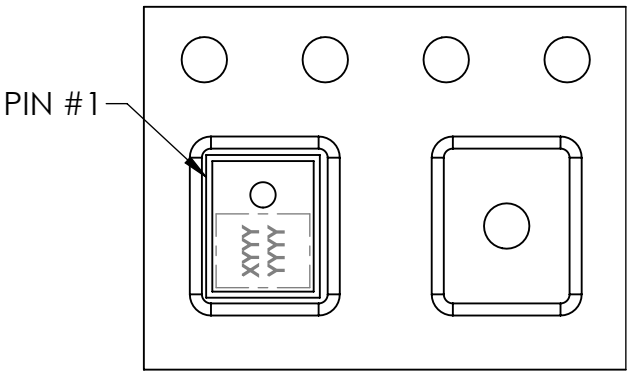
N/A

10. RECOMMENDED INTERFACE CIRCUIT



11. PACKAGING DETAIL





COMPONENT ORIENTATION

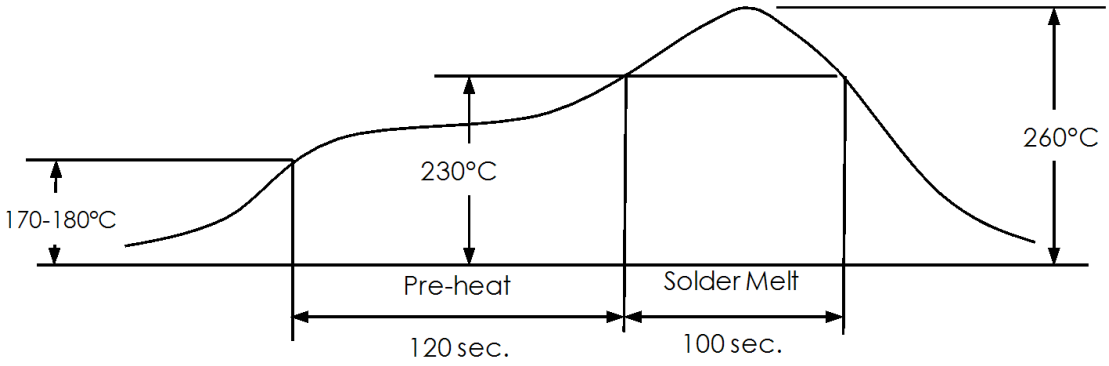
MODEL NUMBER	SUFFIX	REEL DIAMETER	QUANTITY PER REEL
SPM0404HD5-PB (Rev A)	-2	7"	1,200
	-6	13"	4,800

TAPE & REEL	PER EIA-481
LABEL	LABEL APPLIED TO EXTERNAL PACKAGE & DIRECT TO REEL.

Note:

Dimensions are in milimeters unless otherwise specified.

12. SOLDER FLOW PROFILE



Stage	Temperature Profile	Time (maximum)
Pre-heat	170 ~ 180°C	120 sec.
Solder Melt	Above 230°C	100 sec.
Peak	260°C maximum	30 sec.

13. ADDITIONAL NOTES

(A) Shelf life: Twelve (12) months when devices are to be stored in factory supplied, unopened ESD moisture sensitive bag under maximum environmental conditions of 30°C, 70% R.H.
(B) MSL (moisture sensitivity level) Class 2a.
(C) Do not pull a vacuum over port hole of the microphone. Pulling a vacuum over the port hole can damage the device.
(D) Do not board wash after the reflow process. Board washing and cleaning agents can damage the device. Do not expose to ultrasonic processing or cleaning.
(E) Do not brush board after the reflow process. Brushing the board with/without solvents can damage the device.
(F) Do not insert any object in port hole of device at any time as this can damage the device.
(G) Number of reflow - Recommend no more than 3 cycles.

14. RELIABILITY SPECIFICATIONS

Note: After test conditions are performed, the sensitivity of the microphone shall not deviate more than 3dB from its initial value.

Test	Description
Thermal Shock	100 cycles of air-air thermal shock from -40°C to +125°C with 15 minute soaks. (IEC 68-2-4)
High Temperature Storage	+105°C environment for 1,000 hours. (IEC 68-2-2 Test Ba)
Low Temperature Storage	-40°C environment for 1,000 hours. (IEC 68-2-2 Test Aa)
High Temperature Bias	+105°C environment while under bias for 1,000 hours. (IEC 68-2-2 Test Ba)
Low Temperature Bias	-40°C environment while under bias for 1,000 hours. (IEC 68-2-2 Test Aa)
Temperature / Humidity Bias	+85°C/85% R.H. environment while under bias for 1,000 hours. (JESD22-A101A-B)
Vibration	4 cycles lasting 12 minutes from 20 TO 2,000 Hz in X, Y and Z direction with peak acceleration of 20g. (MIL 883E, Method 2007.2, A)
Electrostatic Discharge	3 discharges at +/-8kV direct contact to lid when unit is grounded (IEC 61000-4-2) and 3 discharges at +/-2kV direct contact to I/O pins. (MIL 883E, Method 3015.7)
Reflow	5 reflow cycles with peak temperature of +260°C.
Mechanical Shock	3 pulses of 10,000g in the X, Y and Z direction. (IEC 68-2-27, Test Ea)

15. SPECIFICATION REVISIONS

Revision	Detailed Specification Changes	Date
A	INITIAL DRAWING	1/17/11